

FIGURE 1:

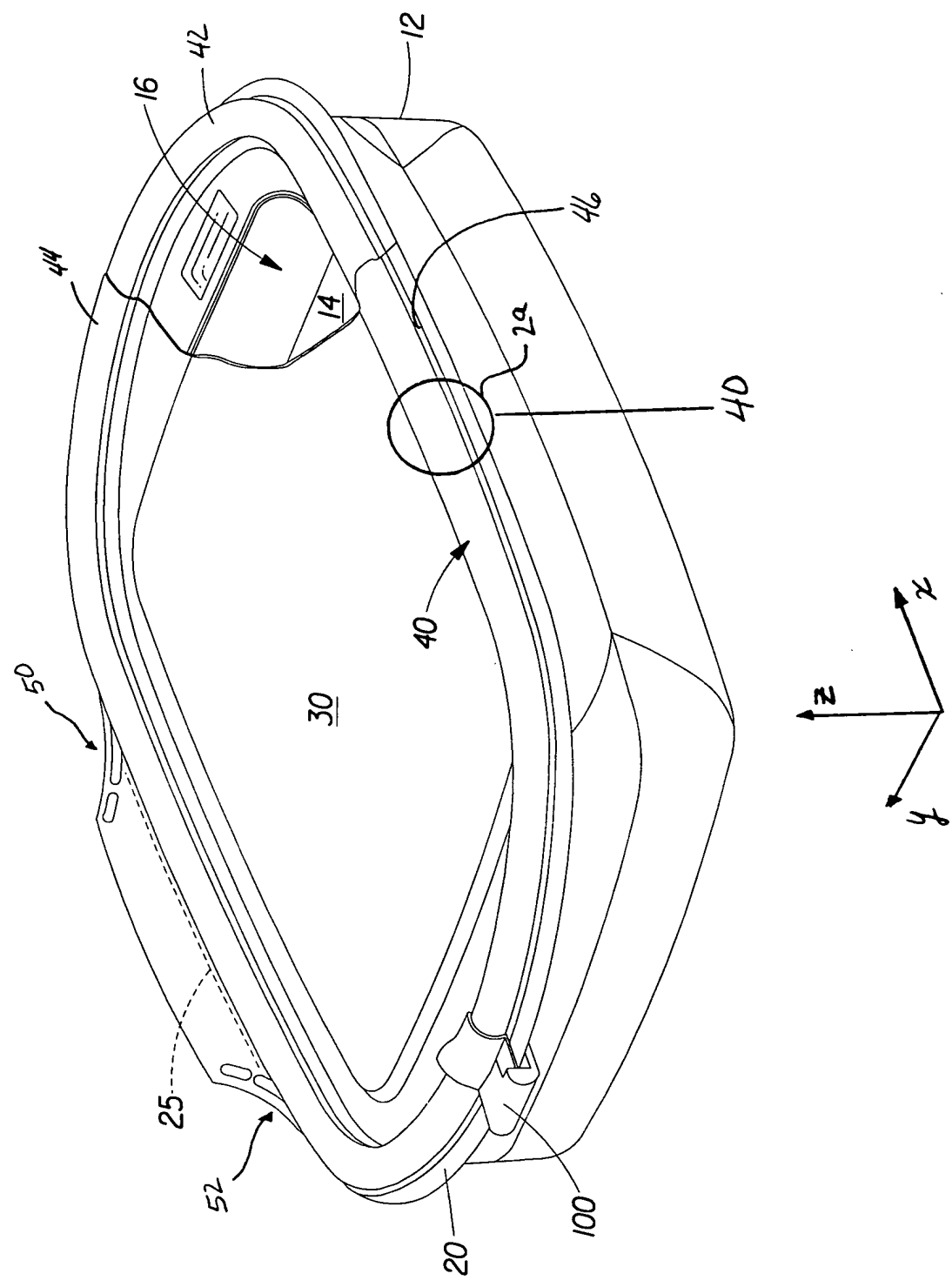


FIGURE 2a.

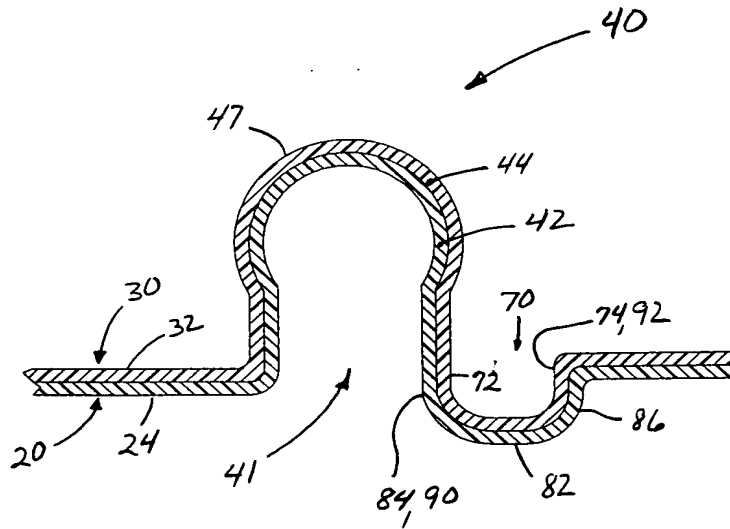


FIGURE 2b:

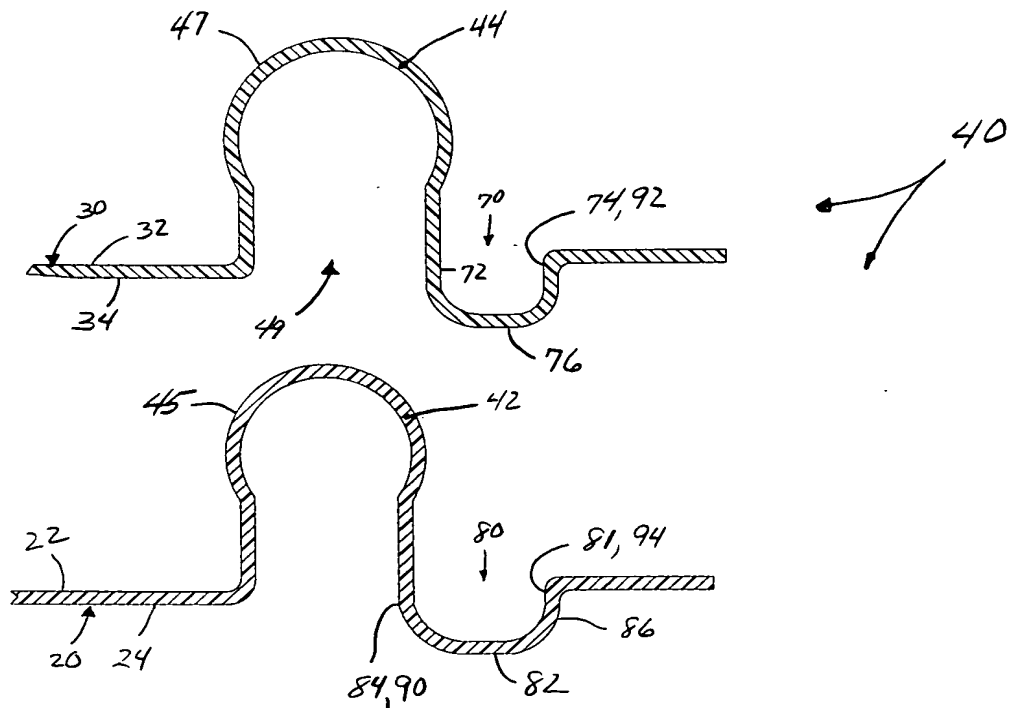


FIGURE 3:

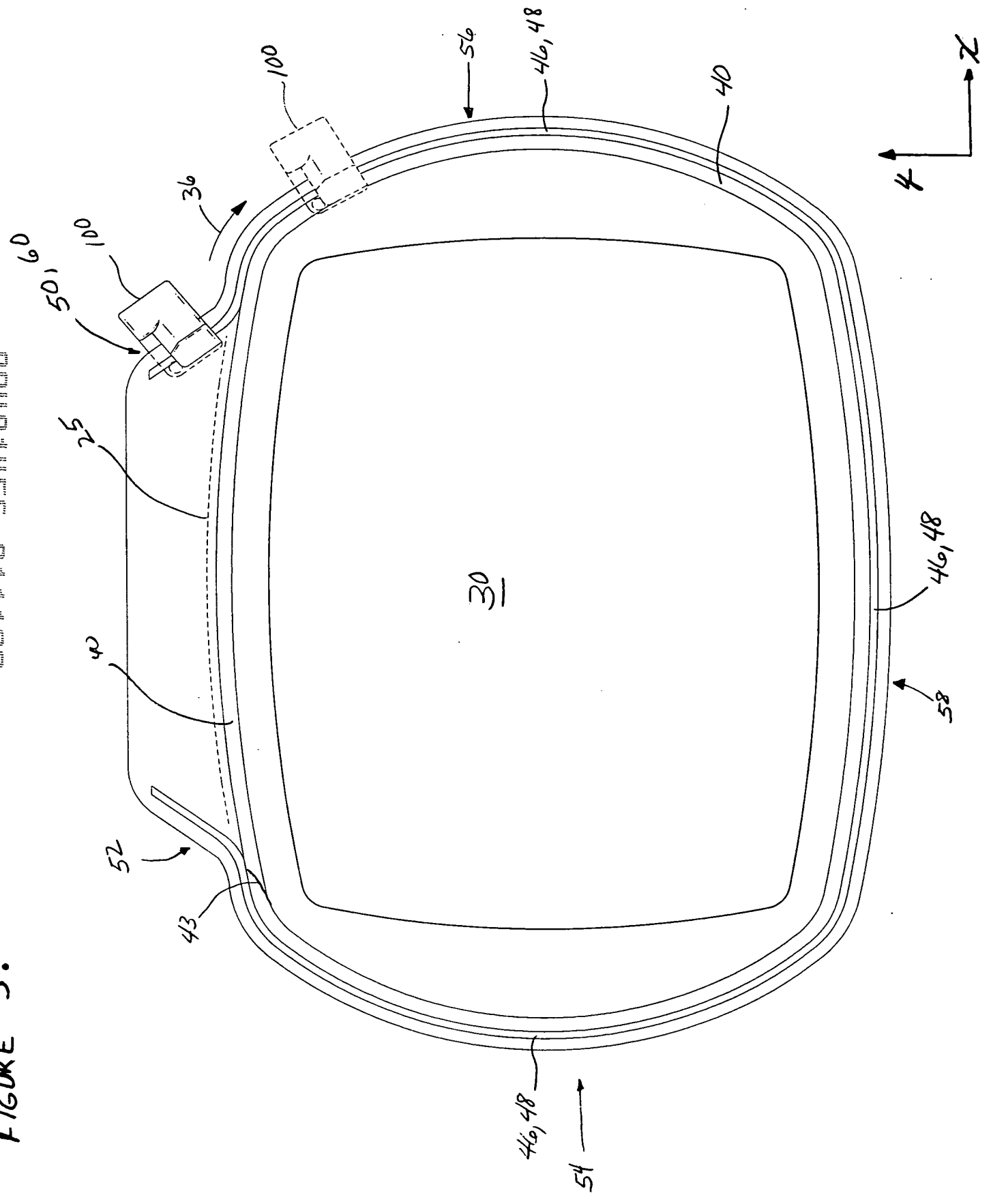


FIGURE 4:

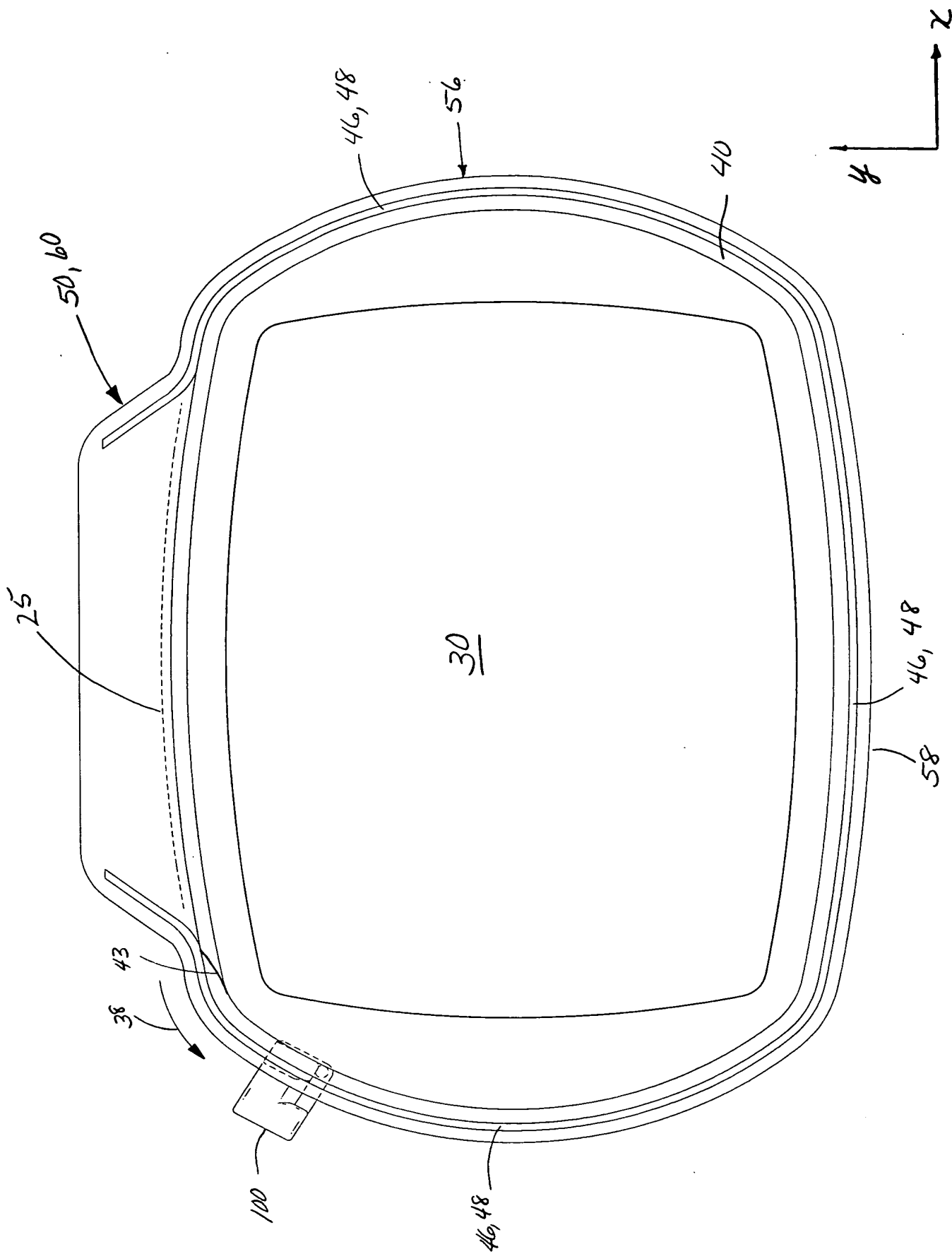




FIGURE 6a:

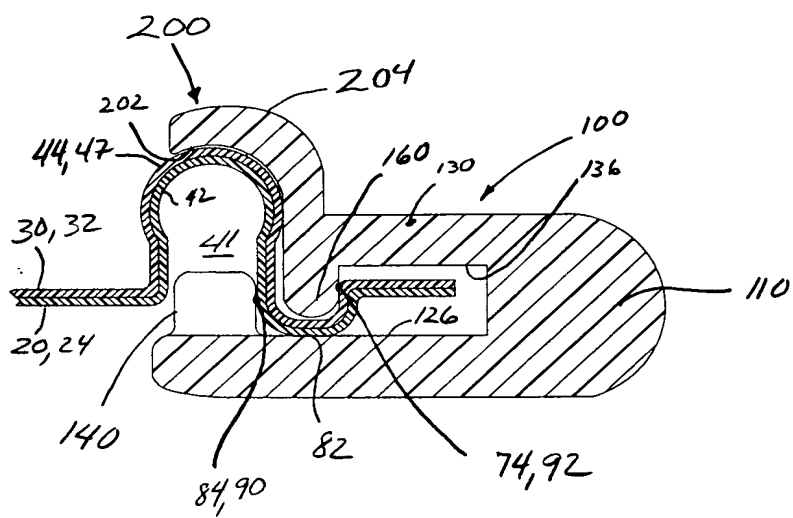
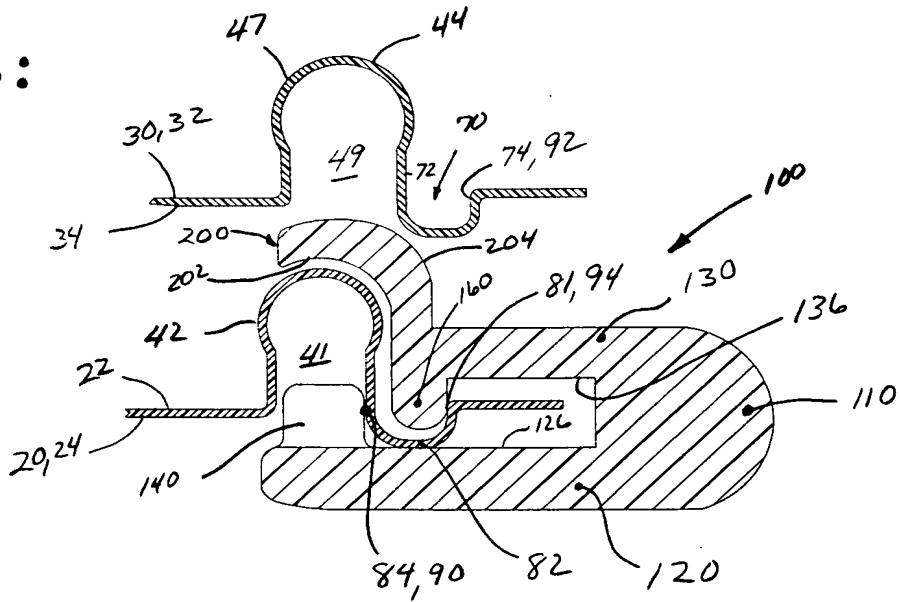
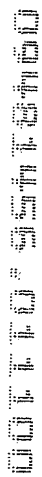
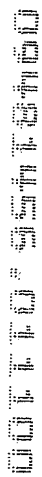


FIGURE 6b:



[illegible][illegible]

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FIGURE 8a:

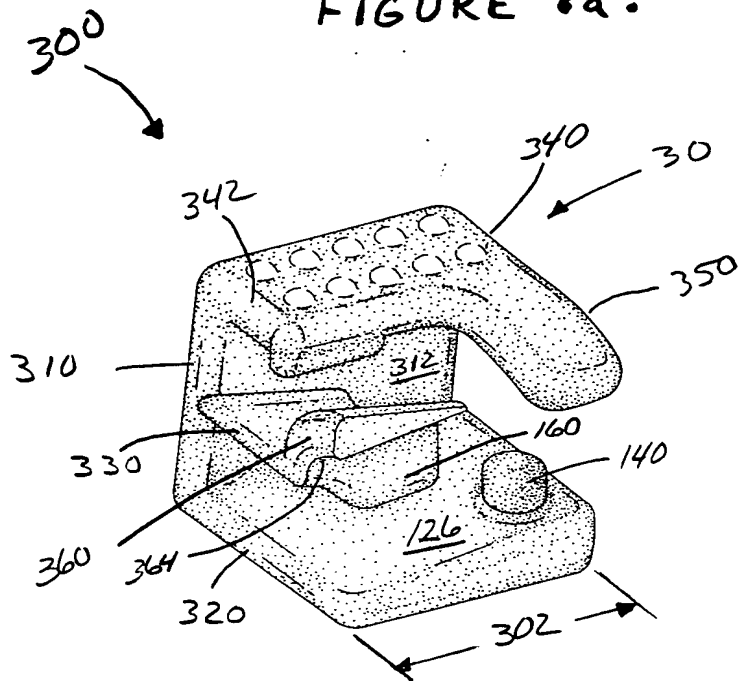


FIGURE 8b:

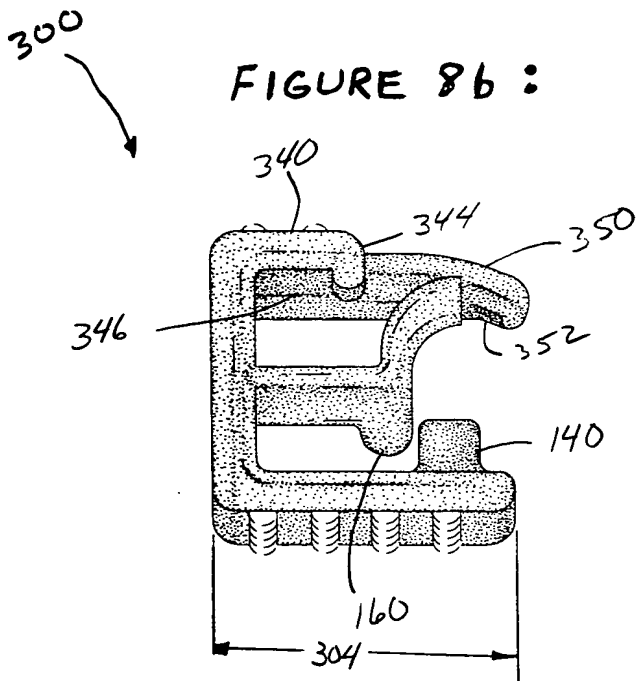
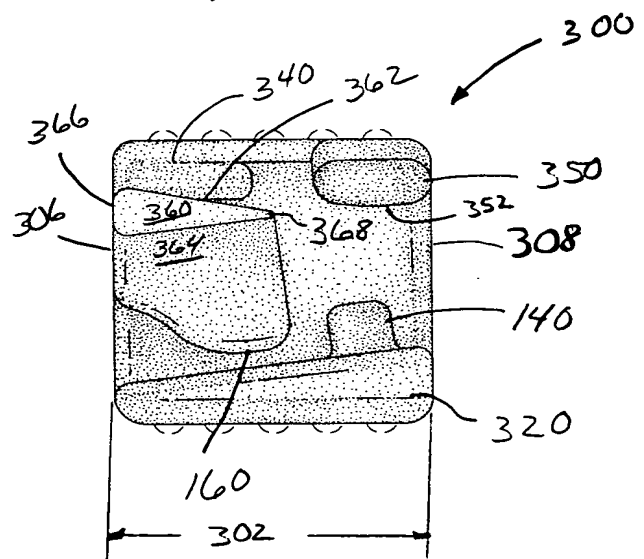
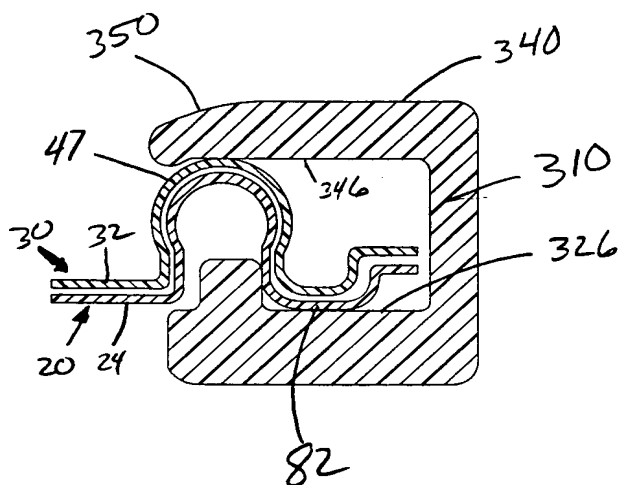


FIGURE 8c:





A cross-sectional view of a device assembly. A central rectangular cavity (310) is formed within a block (340). A protruding feature (326) extends from the right side of the cavity. A curved, U-shaped component (346) is positioned within the cavity. A layer (350) is shown on top of the block. A cross-section of a wire or cable (30) is shown on the left, with its conductive core (32) and insulation (20, 24). A label 47 points to the curved component. A label 82 points to the bottom of the block.



A cross-sectional view of a device assembly. A base component, labeled 320, has a complex profile with a central cavity and side features. A component labeled 310 is positioned on top of the base. A layer or coating, labeled 330, is applied to the top surface of component 310. A curved, ring-like structure, labeled 40, is positioned around the central cavity of the base. This structure has an inner surface labeled 41, 42 and an outer surface labeled 44. A small protrusion or feature on the inner surface is labeled 49. A horizontal line or wire, labeled 364, passes through the structure. Other labels include 360, 362, and 340, which point to various parts of the assembly.

